

TIDA060001 PWM MODE BOM

Comment	Description	Designator	Footprint	Quantity
GR443QR73D102KW01L	CAP, CERM, 1000 pF, 2000 V, +/- 10%	C1, C3	1812	2
GRM1885C1H332JA01D	CAP, CERM, 3300 pF, 50 V, +/- 5%, C0G	C2	0603	1
GRM188R71C103KA01D	CAP, CERM, 0.01 µF, 16 V, +/- 10%, X7R	C4, C13, C14, C19, C20, C21	0603	6
GRM1885C1H561JA01D	CAP, CERM, 560 pF, 50 V, +/- 5%, C0G	C5	0603	1
06035A271JAT2A	CAP, CERM, 270 pF, 50 V, +/- 5%, C0G	C6	0603	1
UMK107AB7105KA-T	CAP, CERM, 1 µF, 50 V, +/- 10%, X7R	C7, C9	0603	2
GRM188R71C102KA01D	CAP, CERM, 1000 pF, 16 V, +/- 10%, X7R	C8, C10	0603	2
160R07X104KV4T	CAP, CERM, 0.1 µF, 16 V, +/- 10%, X5F	C11, C12, C18	0402_065	3
GRT188R61E106ME13D	CAP, CERM, 10 µF, 25 V, +/- 20%, X5R	C15, C22	0603	2
JMK212BJ476MG-T	CAP, CERM, 47 µF, 6.3 V, +/- 20%, X5F	C16	0805_HV	1
0603YC104JAT2A	CAP, CERM, 0.1 µF, 16 V, +/- 5%, X7R	C17	0603	1
GCM188R71H103KA37D	CAP, CERM, 0.01 µF, 50 V, +/- 10%, X7R	C23	0603	1
06035C333JAT2A	CAP, CERM, 0.033 µF, 50 V, +/- 5%, X7R	C24	0603	1
GRM188R71H223KA01D	CAP, CERM, 0.022 µF, 50 V, +/- 10%, X7R	C25	0603	1
06035A102KAT2A	CAP, CERM, 1000 pF, 50 V, +/- 10%, C	C26	0603	1
GRT31CR61H106KE01L	CAP, CERM, 10 µF, 50 V, +/- 10%, X5R	C27	1206_180	1
GRM31MR71E225KA93L	CAP, CERM, 2.2 µF, 25 V, +/- 10%, X7R	Cin1	1206	1
GRM21BR60J226ME39L	CAP, CERM, 22 µF, 6.3 V, +/- 20%, X5F	Cout1	0805_HV	1
1SMB5931BT3G	Diode, Zener, 18 V, 550 mW, SMB	D1	SMB	1
150060BS75000	LED, Blue, SMD	D2	LTST-C193_Blue	1
150060RS75000	LED, Red, SMD	D3	LTST-C191_Red	1
Fiducial	Fiducial mark. There is nothing to buy	FID4, FID5, FID6	Fiducial10-30	3
SSQ-110-03-T-D	Receptacle, 2.54mm, 10x2, Tin, TH	J1	BoosterPack_40pin_J1J3	1
SSQ-110-03-T-D	Receptacle, 2.54mm, 10x2, Tin, TH	J2	BoosterPack_40pin_J2J4	1
961102-6404-AR	Header, 2.54mm, 2x1, TH	J3	3M_961102-6404-AR	1
39357-0002	Terminal Block, 3.5 mm, 2x1, Tin, TH	J4	Molex_39357-0002	1
LPS4018-103MRB	Inductor, Shielded Drum Core, Ferrite	L1	LPS4018	1
DO1608C-334MLB	Inductor, Drum Core, Ferrite, 330 µH	L2	DO1608C	1
DO1608C-474MLB	Inductor, Drum Core, Ferrite, 470 µH	L3	DO1608C	1
LQH2MCN1R0M52	Inductor, Wirewound, Ferrite, 1 µH, 0.5	L4	LQH2MC_52	1
Size: 0.65" x 0.20 "	Thermal Transfer Printable Labels, 0.65	LBL1	Label_650x200	1
CRCW06030000Z0EA	RES, 0, 5%, 0.1 W, 0603	R1, R20, R24, R25	0603	4
CRCW060343K0JNEA	RES, 43 k, 5%, 0.1 W, 0603	R2, R8	0603	2
CRCW040210K0FKED	RES, 10.0 k, 1%, 0.063 W, 0402	R3, R4, R5, R6, R13, R14, R17	0402	7
RC0603JR-07510RL	RES, 510, 5%, 0.1 W, 0603	R9, R12	0603	2
CRCW040233K0JNED	RES, 33 k, 5%, 0.063 W, 0402	R15	0402	1
CRCW0402330RJNED	RES, 330, 5%, 0.063 W, 0402	R16	0402	1
CRCW0603680RJNEA	RES, 680, 5%, 0.1 W, 0603	R18, R19	0603	2
CRCW0603150RFKEA	RES, 150, 1%, 0.1 W, 0603	R22, R23	0603	2
ERJ-6GEYJ4R7V	RES, 4.7, 5%, 0.125 W, 0805	R26	0805_HV	1
RC0603FR-07100KL	RES, 100 k, 1%, 0.1 W, 0603	R27, R28	0603	2
ERJ-2RKF1000X	RES, 100, 1%, 0.1 W, 0402	Rpg1	0402	1
AFE031AIRGZT	Powerline Communications Analog Fr	U1	RGZ0048B - Thicker Vias	1
TPS62177DQCR	28V, 0.5A Step-Down Converter with S	U2	DQC0010A-Edited	1
SN74LVC2G07DBVR	Dual Buffer/Driver with Open-Drain O	U3	DBV0006A_N	1

B350A-13-F	Diode, Schottky, 50 V, 3 A, SMA	U4, U5, U6, U8	SMA	4
------------	---------------------------------	----------------	-----	---

IMPORTANT NOTICE FOR TI DESIGN INFORMATION AND RESOURCES

Texas Instruments Incorporated ("TI") technical, application or other design advice, services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using any particular TI Resource in any way, you (individually or, if you are acting on behalf of a company, your company) agree to use it solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources.

You understand and agree that you remain responsible for using your independent analysis, evaluation and judgment in designing your applications and that you have full and exclusive responsibility to assure the safety of your applications and compliance of your applications (and of all TI products used in or for your applications) with all applicable regulations, laws and other applicable requirements. You represent that, with respect to your applications, you have all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. You agree that prior to using or distributing any applications that include TI products, you will thoroughly test such applications and the functionality of such TI products as used in such applications. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

You are authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING TI RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY YOU AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

You agree to fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of your non-compliance with the terms and provisions of this Notice.

This Notice applies to TI Resources. Additional terms apply to the use and purchase of certain types of materials, TI products and services. These include; without limitation, TI's standard terms for semiconductor products (<http://www.ti.com/sc/docs/stdterms.htm>), [evaluation modules](#), and [samples](http://www.ti.com/sc/docs/sampterm.htm) (<http://www.ti.com/sc/docs/sampterm.htm>).

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2018, Texas Instruments Incorporated